International **ICR** Rectifier

POWER MOSFET THRU-HOLE (TO-254AA)

Product Summary

Part Number	RDS(on)	ID		
IRFM9140	0.20Ω	-18A		

HEXFET[®] MOSFET technology is the key to International Rectifier's advanced line of power MOSFET transistors. The efficient geometry design achieves very low on-state resistance combined with high transconductance. HEXFET transistors also feature all of the well-established advantages of MOSFETs, such as voltage control, very fast switching, ease of paralleling and electrical parameter temperature stability. They are well-suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers, high energy pulse circuits, and virtually any application where high reliability is required. The HEXFET transistor's totally isolated package eliminates the need for additional isolating material between the device and the heatsink. This improves thermal efficiency and reduces drain capacitance.

Absolute Maximum Ratings

PD - 90495G

IRFM9140 JANTX2N7236 JANTXV2N7236 JANS2N7236 REF:MIL-PRF-19500/595 100V, P-CHANNEL HEXFET[®] MOSFETTECHNOLOGY



Features:

- Simple Drive Requirements
- Ease of Paralleling
- Hermetically Sealed
- Electrically Isolated
- Dynamic dv/dt Rating
- Light-weight

	Devenueter		Linite	
	Parameter		Units	
$I_D @ V_{GS} = -10V, T_C = 25^{\circ}C$	Continuous Drain Current	-18		
$I_D @ V_{GS} = -10V, T_C = 100^{\circ}C$	Continuous Drain Current	-11	A	
IDM	Pulsed Drain Current ①	-72		
P _D @ T _C = 25°C	Max. Power Dissipation	125	W	
	Linear Derating Factor	1.0	W/°C	
VGS	Gate-to-Source Voltage	±20	V	
EAS	Single Pulse Avalanche Energy 2	500	mJ	
IAR	Avalanche Current ①	-18	A	
EAR	Repetitive Avalanche Energy ①	12.5	mJ	
dv/dt	Peak Diode Recovery dv/dt 3	-5.5	V/ns	
TJ	Operating Junction	-55 to 150		
TSTG	Storage Temperature Range		°C	
	Lead Temperature	300 (0.063 in.(1.6mm) from case for 10s)		
	Weight	9.3 (typical)	g	

For footnotes refer to the last page

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Electrical Characteristics @ Tj = 25°C (Unless Otherwise Specified)

	Parameter	Min	Тур	Max	Units	Test Conditions
BVDSS	Drain-to-Source Breakdown Voltage	-100	_	—	V	$V_{GS} = 0V, I_{D} = -1.0mA$
ΔBV _{DSS} /ΔTJ	Temperature Coefficient of Breakdown Voltage	_	-0.087	_	V/°C	Reference to 25°C, ID = -1.0mA
RDS(on)	Static Drain-to-Source On-State	_	—	0.20	Ω	VGS = -10V, ID = -11A4
	Resistance	_	—	0.22	52	VGS = -10V, ID = -18A ④
VGS(th)	Gate Threshold Voltage	-2.0	—	-4.0	V	$V_{DS} = V_{GS}$, $I_D = -250 \mu A$
9fs	Forward Transconductance	6.2	—	—	S (🗘)	V _{DS} > -15V, I _{DS} = -11A④
IDSS	Zero Gate Voltage Drain Current	_	—	-25		VDS= -80V, VGS= 0V
		—	—	-250	μΑ	V _{DS} = -80V
						$V_{GS} = 0V, T_{J} = 125^{\circ}C$
IGSS	Gate-to-Source Leakage Forward	—	—	-100	nA	VGS = -20V
IGSS	Gate-to-Source Leakage Reverse	_	—	100		VGS =20V
Qg	Total Gate Charge	_	—	60		$V_{GS} = -10V, ID_{=} -18A$
Qgs	Gate-to-Source Charge		—	13	nC	VDS = -50V
Qgd	Gate-to-Drain ('Miller') Charge	_	—	35.2		
^t d(on)	Turn-On Delay Time	—	—	35		V _{DD} = -50V, I _D = -11A
tr	Rise Time	_	—	85	ns	RG = 9.1Ω, VGS = -10V
td(off)	Turn-Off Delay Time	_	—	85	115	
tf	Fall Time	_	—	65		
LS + LD	Total Inductance		6.8		nH	Measured from drain lead (6mm/ 0.25in. from package) to source lead (6mm/0.25in. from package)
C _{iss}	Input Capacitance	_	1400			$V_{GS} = 0V, V_{DS} = -25V$
C _{OSS}	Output Capacitance	_	600	—	pF	f = 1.0MHz
C _{rss}	Reverse Transfer Capacitance	—	200	—		

Source-Drain Diode Ratings and Characteristics

	Parameter		Min	Тур	Max	Units	Test Conditions
IS	Continuous Source Current (Body Diode)	_	_	-18	Α	
ISM	Pulse Source Current (Body	Diode) ①	—	—	-72		
VSD	Diode Forward Voltage		_	_	-5.0	V	$T_j = 25^{\circ}C, I_S = -18A, V_{GS} = 0V @$
trr	Reverse Recovery Time		_	_	280	nS	Tj = 25°C, IF = -18A, di/dt ≤-100A/μs
QRR	Reverse Recovery Charge		—	_	3.6	μς	$V_{DD} \leq -50V $ (4)
ton	Forward Turn-On Time	Intrinsic turn-on time is negligible. Turn-on speed is substantially controlled by $L_S + L_D$.					

Thermal Resistance

	Parameter	Min	Тур	Max	Units	Test Conditions
RthJC	Junction-to-Case	—	_	1.0		
RthCS	Case-to-sink	—	0.21	—	°C/W	
R _{th} JA	Junction to Ambient	—	—	48		Typical socket mount

Note: Corresponding Spice and Saber models are available on International Rectifier Website.

For footnotes refer to the last page

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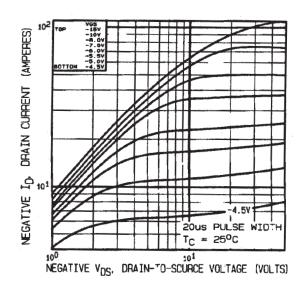


Fig 1. Typical Output Characteristics

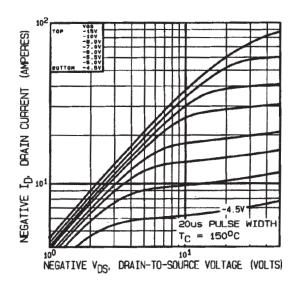
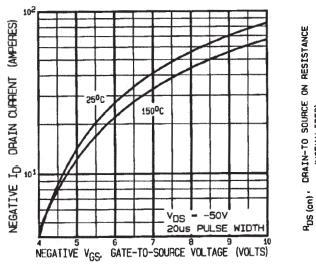


Fig 2. Typical Output Characteristics





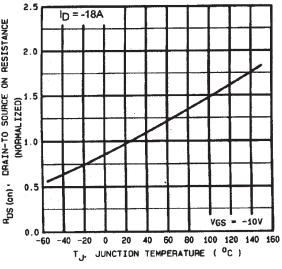


Fig 4. Normalized On-Resistance Vs. Temperature

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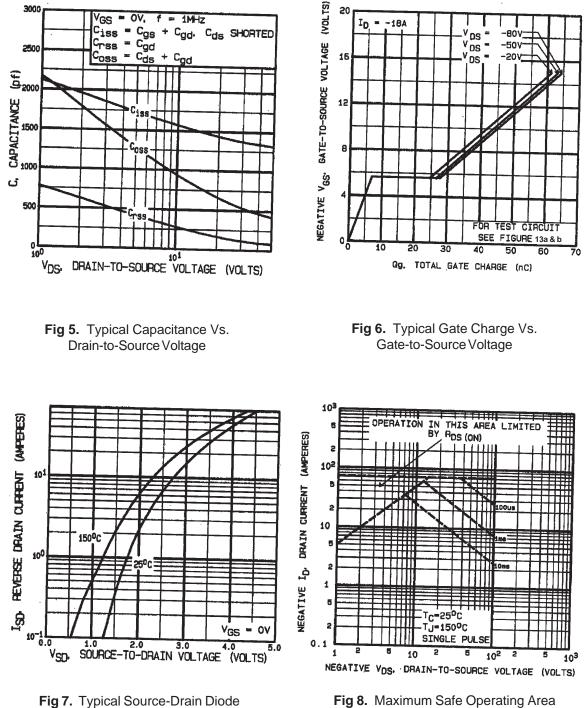
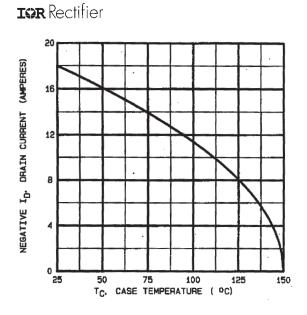


Fig 8. Maximum Safe Operating Area

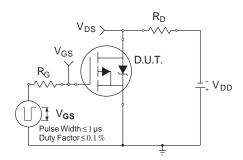
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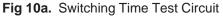
Forward Voltage



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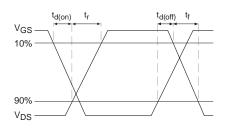


Fig 10b. Switching Time Waveforms

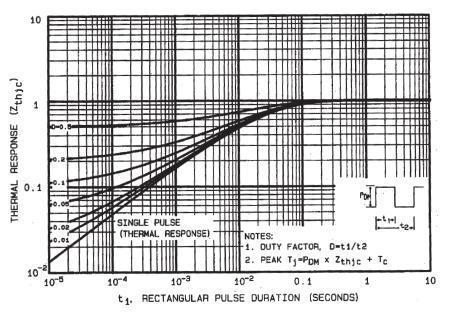
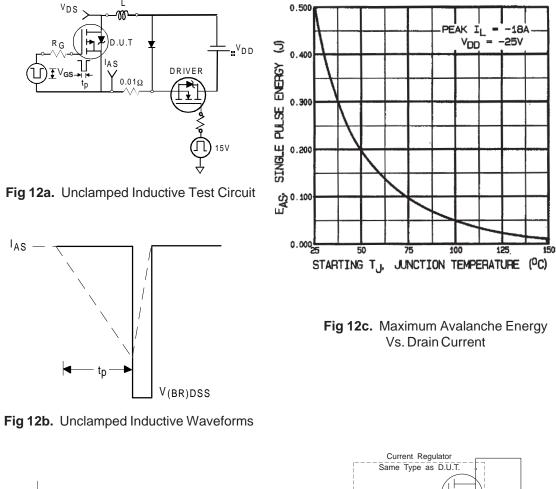


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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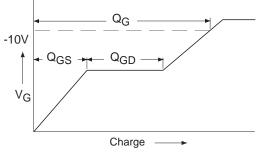


Fig 13a. Basic Gate Charge Waveform

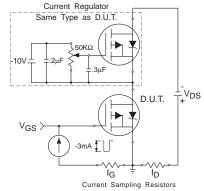


Fig 13b. Gate Charge Test Circuit

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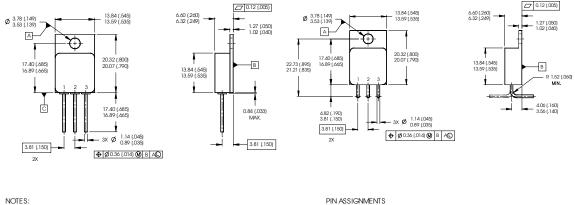
Foot Notes:

- 1 Repetitive Rating; Pulse width limited by maximum junction temperature.
- ② V_{DD} =-25V, starting T_J = 25°C, L = 3.1mH Peak IL = -18A, VGS = -10V

 \bigcirc ISD \leq -18A, di/dt \leq -100A/µs, $V_{DD} \le -100V$, $T_J \le 150^{\circ}C$

④ Pulse width \leq 300 µs; Duty Cycle \leq 2%

Case Outline and Dimensions — TO-254AA



1. DIMENSIONING & TOLERANCING PER ASME Y14.5M-1994. 2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).

3. CONTROLLING DIMENSION: INCH. 4. CONFORMS TO JEDEC OUTLINE TO 254AA.

CAUTION **BERYLLIA WARNING PER MIL-PRF-19500**

1 = DRAIN 2 = SOURCE 3 = GATE

Packages containing beryllia shall not be ground, sandblasted, machined or have other operations performed on them which will produce beryllia or beryllium dust. Furthermore, beryllium oxide packages shall not be placed in acids that will produce fumes containing beryllium.

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